Small Signal MOSFET

25 V, 1.2 A, Single, N-Channel, SC-88

Features

- Advance Planar Technology for Fast Switching, Low RDS(on)
- Higher Efficiency Extending Battery Life
- Pb–Free Packages are Available

Applications

- Boost and Buck Converter
- Load Switch
- Battery Protection

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

· · · · · · · · · · · · · · · · · · ·	0		,		
Rating			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	25	V
Gate-to-Source Voltage			V _{GS}	±8.0	V
Drain Current	t < 5 s	$T_A = 25^{\circ}C$	Ι _D	1.2	А
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$	۱ _D	1.0	А
(Note 1)		$T_A = 75^{\circ}C$		0.80	
Power Dissipation (Note 1)	Steady State		PD	0.63	W
Power Dissipation (Note 1)	t ≤ 5 s		PD	0.89	W
Pulsed Drain Current	t _p =	i 10 μs	I _{DM}	3.7	А
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to +150	°C
Source Current (Body Diode) (Note 1)			۱ _S	0.8	А
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C
ESD Rating – Machine Model				250	V

THERMAL RESISTANCE RATINGS

Rating	Symbol	Max	Unit
Junction-to-Lead - Steady State (Note 1)	R_{\thetaJL}	102	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	200	
Junction-to-Ambient - t \leq 5 s (Note 1)	$R_{\theta JA}$	140	

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

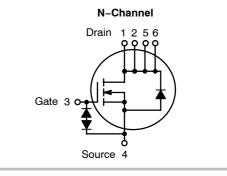
1. Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).



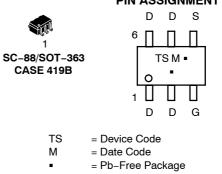
ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
25 V	249 mΩ @ 4.5 V	1.2 A
	299 mΩ @ 2.7 V	1.2 A



MARKING DIAGRAM & PIN ASSIGNMENT



(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping†
NTJS4405NT1	SC-88	3000 / Tape & Reel
NTJS4405NT1G	SC-88 (Pb-Free)	3000 / Tape & Reel
NTJS4405NT4	SC-88	10,000 / Tape & Reel
NTJS4405NT4G	SC-88 (Pb-Free)	10,000 / Tape & Reel

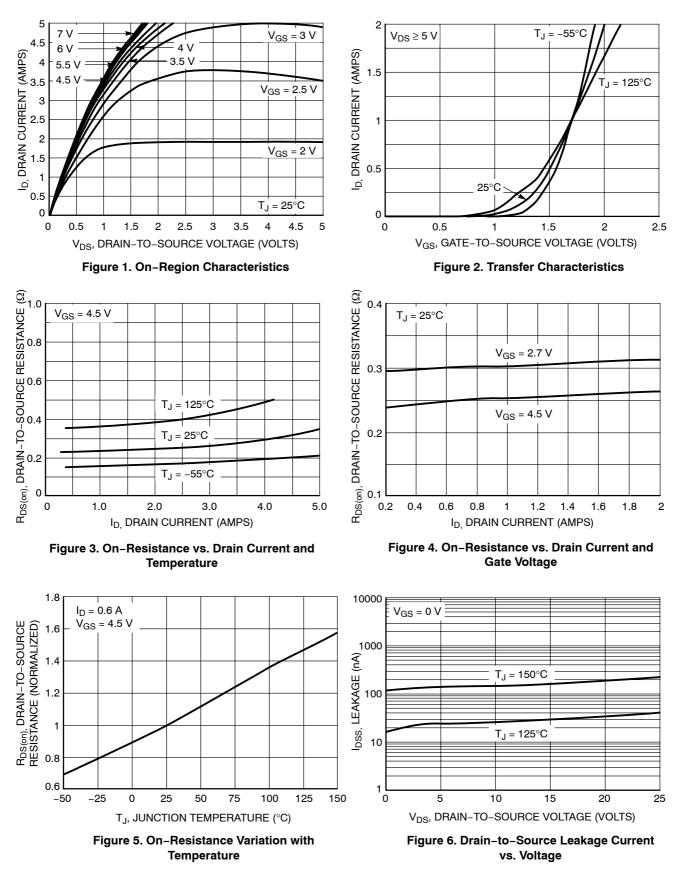
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

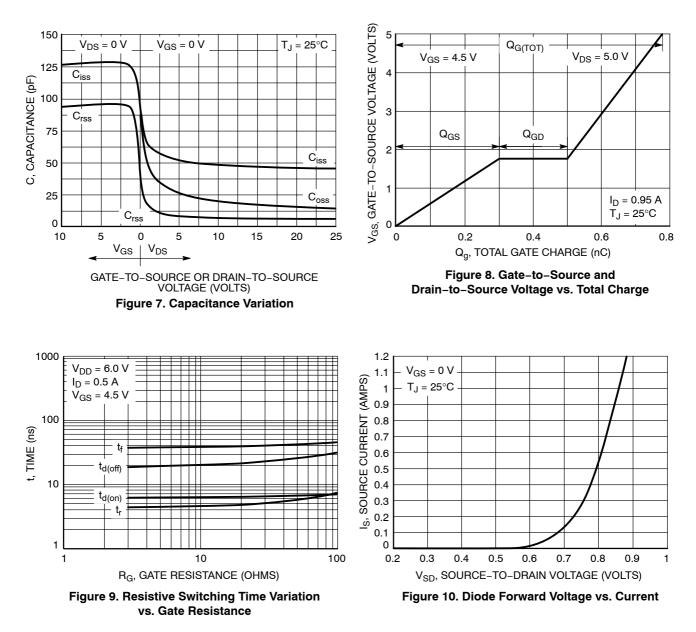
Characteristic	Symbol	Test Condition		Min	Тур	Мах	Unit
OFF CHARACTERISTICS						•	•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		25		1	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				30		mV/°C
Zero Gate Voltage Drain Current	I _{DSS} V	V _{GS} = 0 V,	$T_J = 25^{\circ}C$			1.0	μA
		$V_{DS} = 20 V$	T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 8.0 V				100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		0.65		1.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-2.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.6 \text{ A}$ $V_{GS} = 2.7 \text{ V}, \text{ I}_{D} = 0.2 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 1.2 \text{ A}$			249	350	mΩ
					299	400	
					260		
Forward Transconductance	9 _{FS}	V _{DS} = 5.0 V, I _D = 0.5 A			0.5		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				49	60	pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 10 V			22.4	30	1
Reverse Transfer Capacitance	C _{RSS}	- 53			8.0	12	1
Total Gate Charge	Q _{G(TOT)}				0.75	1.5	nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V	_{DS} = 5.0 V,		0.10		
Gate-to-Source Charge	Q _{GS}	V_{GS} = 4.5 V, V_{DS} = 5.0 V, I _D = 0.95 A			0.30	0.50	
Gate-to-Drain Charge	Q _{GD}				0.20	0.40	
SWITCHING CHARACTERISTICS (No	ote 3)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V _{DS} = 6.0 V, I _D = 0.5 A, R _G = 50 Ω			6.0	12	ns
Rise Time	t _r				4.7	8.0	
Turn-Off Delay Time	t _{d(OFF)}				25	35	
Fall Time	t _f				41	60	
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 0.6 A	$T_J = 25^{\circ}C$		0.82	1.20	V
	-		-		-	•	

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.



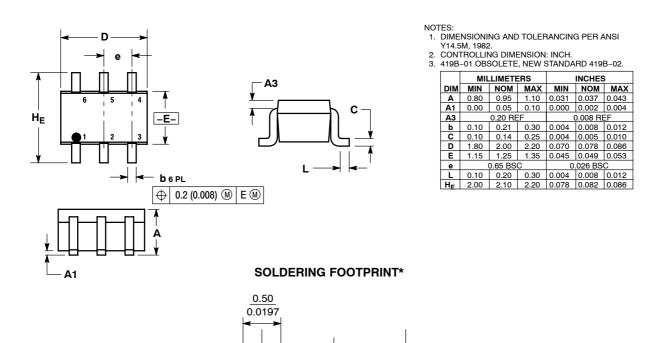
TYPICAL PERFORMANCE CURVES (T_J = 25° C unless otherwise noted)





PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02 **ISSUE W**



0.0748 $\left(\frac{\text{mm}}{\text{inches}}\right)$ SCALE 20:1 *For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and

1.9

0.65 0.025

0.65 0.025

Mounting Techniques Reference Manual, SOLDERRM/D.

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